Certificate IATF 0526651 Certificate CN06/22171.05



The management system of

JCET Advanced Packaging Co., Ltd.

IATF USI: 6Z5R54

No. 78, Changshan Rd., Chengjiang Town, Jiangyin, Jiangsu, P. R. China

has been assessed and certified as meeting the requirements of

IATF 16949:2016

Edition 1

For the following Scope

Wafer Bumping and Wafer level chip scale Packages /3D packages with Probing

EXCLUSIONS: 8.3 Product Design

3 Year certification is valid from 27 June 2024 until 26 June 2027 and remains valid subject to satisfactory surveillance audits.

Version no. 4. Current version updated 27 June 2024

Authorised by

David ZHENG

Veto Power Authority

Contracted Office: SGS United Kingdom Ltd, Station Road, Oldbury, B69 4LN, UK.

Email: Neil.Hall@sgs.com





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JCET Advanced Packaging Co., Ltd.

IATF 16949:2016

Edition 1

Additional facilities

Support Function

JCET Group Co., Ltd.

IATF USI: GP6FCE

No. 275, Binjiang Rd, Jiangyin City, Jiangsu Province, P. R. China

Summary of Activities

Strategic Planning, Policy Making, Quality System Management, Internal Audit Management, Marketing, Sales, Customer Service, Supplier Management, Management Review, Training, Information Technology, Purchasing, Contract Review, Human Resources







